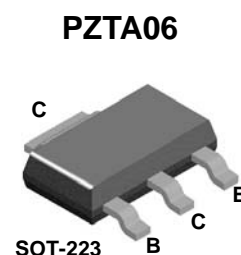
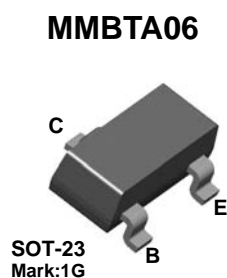
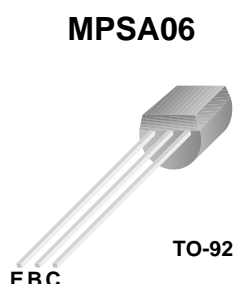


MPSA06 / MMBTA06 / PZTA06

NPN General Purpose Amplifier

Features

- This device is designed for general purpose amplifier applications at collector currents to 300mA.
- Sourced from Process 33.



Absolute Maximum Ratings * $T_a = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Value	Units
V_{CEO}	Collector-Emitter Voltage	80	V
V_{CBO}	Collector-Base Voltage	80	V
V_{EBO}	Emitter-Base Voltage	4.0	V
I_C	Collector Current - Continuous	500	mA
T_J, T_{stg}	Operating and Storage Junction Temperature Range	- 55 to +150	$^\circ\text{C}$

* These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES:

- 1) These ratings are based on a maximum junction temperature of 150 degrees C.
- 2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Thermal Characteristics $T_a = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Max.			Units
		MPSA06	*MMBTA06	**PZTA06	
P_D	Total Device Dissipation	625	350	1,000	mW
	Derate above 25°C	5.0	2.8	8.0	mW/ $^\circ\text{C}$
$R_{\theta JC}$	Thermal Resistance, Junction to Case	83.3			$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	200	357	125	$^\circ\text{C}/\text{W}$

* Device mounted on FR-4 PCB $1.6'' \times 1.6'' \times 0.06''$.

** Device mounted on FR-4 PCB $36\text{mm} \times 18\text{mm} \times 1.5\text{mm}$; mounting pad for the collector lead min. 6cm^2 .

Electrical Characteristics $T_a = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Max.	Units
Off Characteristics					
$V_{(BR)CEO}$	Collector-Emitter Breakdown Voltage*	$I_C = 1.0\text{mA}$, $I_B = 0$	80		V
$V_{(BR)EBO}$	Emitter-Base Breakdown Voltage	$I_E = 100\mu\text{A}$, $I_C = 0$	4.0		V
I_{CEO}	Collector-Cutoff Current	$V_{CE} = 60\text{V}$, $I_B = 0$		0.1	μA
I_{CBO}	Collector-Cutoff Current	$V_{CB} = 80\text{V}$, $I_E = 0$		0.1	μA
On Characteristics					
h_{FE}	DC Current Gain	$I_C = 10\text{mA}$, $V_{CE} = 1.0\text{V}$ $I_C = 100\text{mA}$, $V_{CE} = 1.0\text{V}$	100 100		
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_C = 100\text{mA}$, $I_B = 10\text{mA}$		0.25	V
$V_{BE(on)}$	Base-Emitter On Voltage	$I_C = 100\text{mA}$, $V_{CE} = 1.0\text{V}$		1.2	V
Small Signal Characteristics					
f_T	Current Gain - Bandwidth Product	$I_C = 10\text{mA}$, $V_{CE} = 2.0\text{V}$, $f = 100\text{MHz}$	100		MHz

* Pulse Test: Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2.0\%$

Typical Performance Characteristics

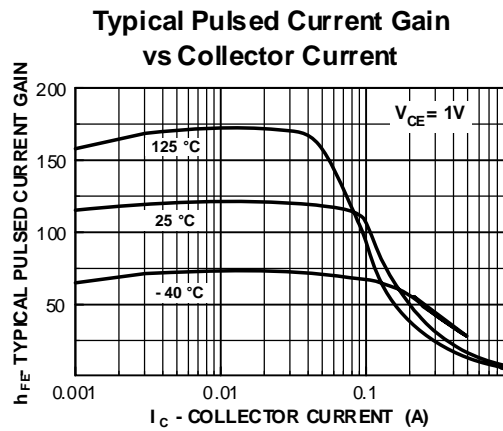


Figure 1. Typical Pulsed Current Gain vs Collector Current

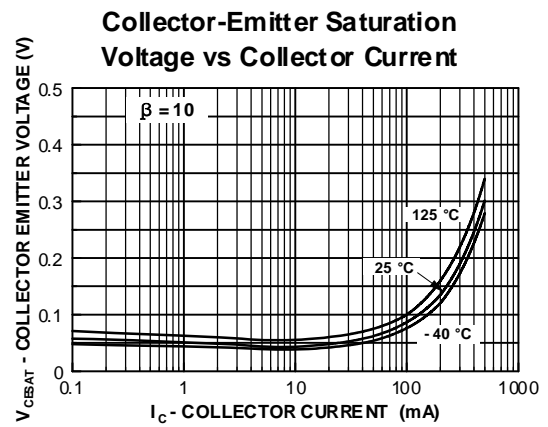


Figure 2. Collector-Emitter Saturation Voltage vs Collector Current

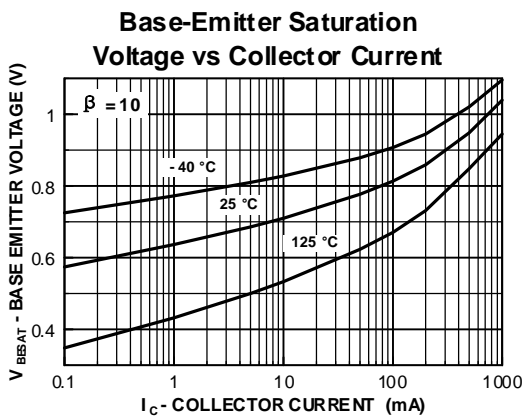


Figure 3. Base-Emitter Saturation Voltage vs Collector Current

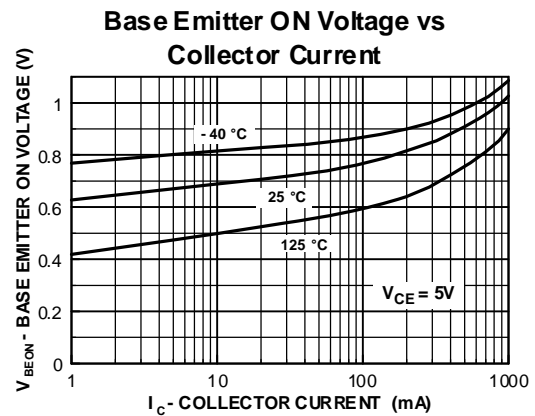


Figure 4. Base-Emitter On Voltage vs Collector Current

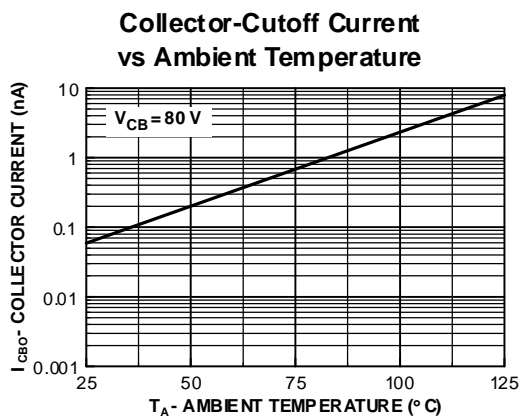


Figure 5. Collector Cutoff Current vs Ambient Temperature

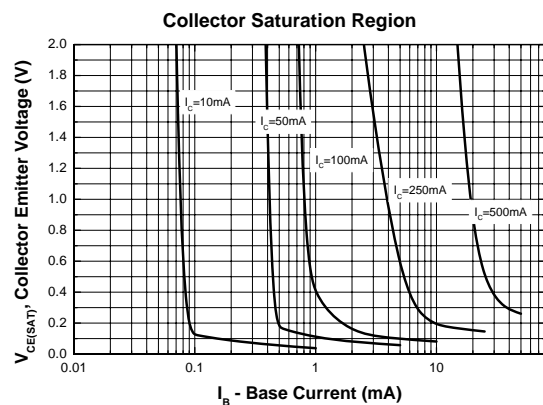


Figure 6. Collector Saturation Region

Typical Performance Characteristics (continued)

Collector-Emitter Breakdown Voltage with Resistance Between Emitter-Base

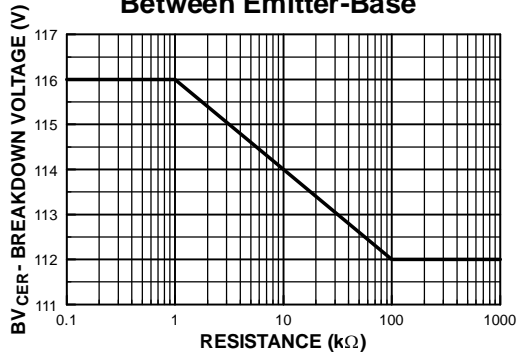


Figure 7. Collector-Emitter Breakdown Voltage with Resistance Between Emitter-Base

Input and Output Capacitance vs Reverse Voltage

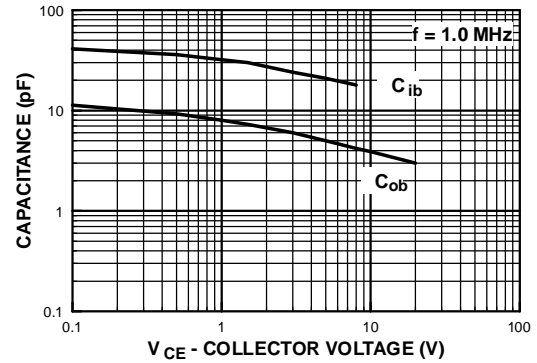


Figure 8. Input and Output Capacitance vs Reverse Voltage

Gain Bandwidth Product vs Collector Current

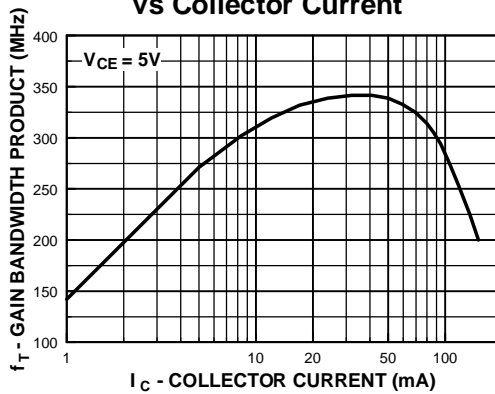


Figure 9. Gain Bandwidth Product vs Collector Current

Power Dissipation vs Ambient Temperature

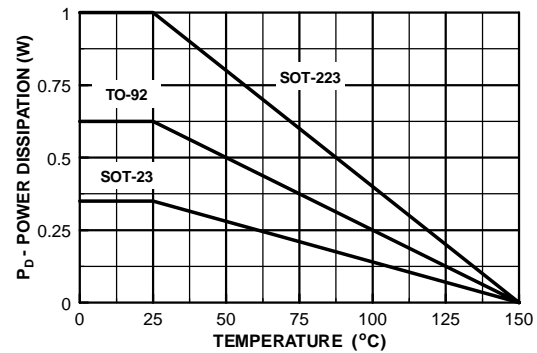







Figure 10. Power Dissipation vs Ambient Temperature



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